# imall

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## Dual Common Base-Collector Bias Resistor Transistors

#### NPN and PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the EMC2DXV5T1G series, two complementary BRT devices are housed in the SOT–553 package which is ideal for low power surface mount applications where board space is at a premium.

#### Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These are Pb–Free Devices

**MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$  unless otherwise noted, common for  $Q_1$  and  $Q_2$ , – minus sign for  $Q_1$  (PNP) omitted)

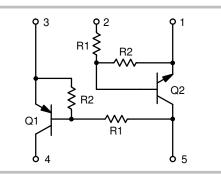
Rating	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	Vdc
Collector-Emitter Voltage	V <sub>CEO</sub>	50	Vdc
Collector Current	۱ <sub>C</sub>	100	mAdc

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



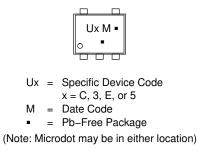
#### **ON Semiconductor®**







#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit	
ONE JUNCTION HEATED				
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C	PD	357 (Note 1) 2.9 (Note 1)	m₩ mW/°C	
Thermal Resistance, Junction-to-Ambient	R <sub>0JA</sub>	350 (Note 1)	°C/W	
BOTH JUNCTIONS HEATED				
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C	PD	500 (Note 1) 4.0 (Note 1)	m₩ mW/°C	
Thermal Resistance, Junction-to-Ambient	R <sub>0JA</sub>	250 (Note 1)	°C/W	
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

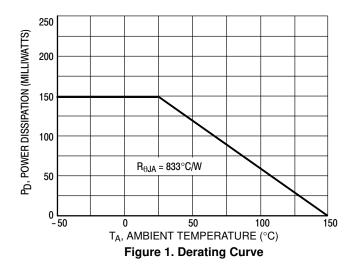
1. FR-4 @ Minimum Pad

#### DEVICE ORDERING INFORMATION, MARKING AND RESISTOR VALUES

		Transisto	or 1 – PNP	Transistor 2 – NPN		Transistor 2 – NPN			
Device	Marking	R1 (K)	R2 (K)	R1 (K)	R2 (K)	Package	Shipping <sup>†</sup>		
EMC2DXV5T1G	UC	22	22	22	22		4000 / Tape & Reel		
NSVEMC2DXV5T1G*	UC	22	22	22	22		4000 / Tape & Reel		
EMC3DXV5T1G	110	10	10	10	10	SOT–553 (Pb–Free)	4000 / Tape & Reel		
EMC3DXV5T5G	U3	10	10	10	10		8000 / Tape & Reel		
EMC4DXV5T1G	UE	10	47	47	47		4000 / Tape & Reel		
EMC5DXV5T1G	U5	4.7	10	47	47		4000 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

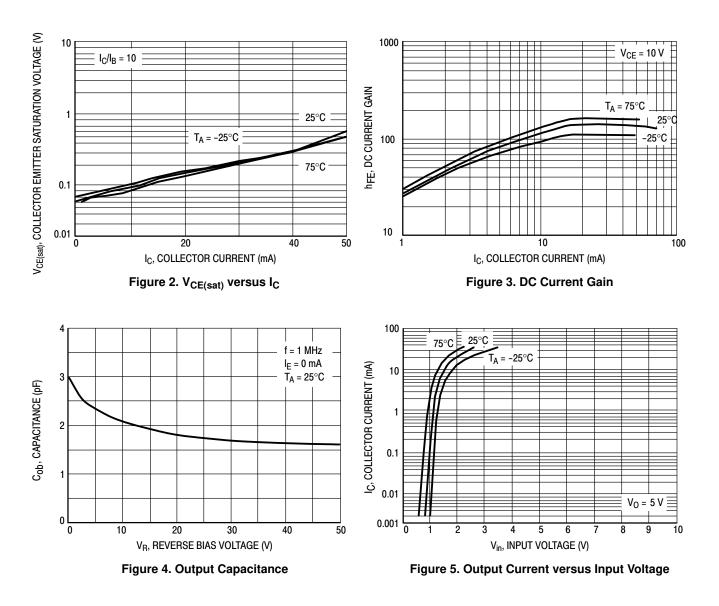


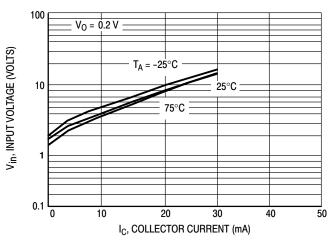
ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25°C unless otherwise no	ted)
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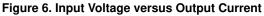
Cha	Symbol	Min	Тур	Max	Unit	
Q1 TRANSISTOR: PNP OFF CHARACTERISTICS						
Collector-Base Cutoff Current (	$V_{CB} = 50 \text{ V}, \text{ I}_{E} = 0)$	I <sub>CBO</sub>	_	_	100	nAdc
Collector-Emitter Cutoff Current	: (V <sub>CB</sub> = 50 V, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	-	500	nAdc
Emitter-Base Cutoff Current ( $V_{EB} = 6.0 \text{ V}, I_C = 0$ )	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G EMC5DXV5T1G	I <sub>EBO</sub>	- - - -	- - - -	0.2 0.5 0.2 1.0	mAdc
ON CHARACTERISTICS						•
Collector-Base Breakdown Volt	age (I <sub>C</sub> = 10 μA, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	50	-	-	Vdc
Collector-Emitter Breakdown Vo	bltage ( $I_{C} = 2.0 \text{ mA}, I_{B} = 0$ )	V <sub>(BR)CEO</sub>	50	-	-	Vdc
DC Current Gain $(V_{CE} = 10 \text{ V}, I_C = 5.0 \text{ mA})$	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G EMC5DXV5T1G	h <sub>FE</sub>	60 35 80 20	100 60 140 35	_ _ _ _	
Collector-Emitter Saturation Vo	ltage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0.3 mA)	V <sub>CE(SAT)</sub>	-	-	0.25	Vdc
Output Voltage (on) (V <sub>CC</sub> = 5.0	V, V <sub>B</sub> = 2.5 V, R <sub>L</sub> = 1.0 kΩ)	V <sub>OL</sub>	-	-	0.2	Vdc
Output Voltage (off) ( $V_{CC} = 5.0$	V, V <sub>B</sub> = 0.5 V, R <sub>L</sub> = 1.0 kΩ)	V <sub>OH</sub>	4.9	-	-	Vdc
Input Resistor	EMC2DXV5T1G EMC3DXV5T1G, EMC4DXV5T1G EMC5DXV5T1G	R1	15.4 7.0 3.3	22 10 4.7	28.6 13 6.1	kΩ
Resistor Ratio	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G EMC5DXV5T1G	R1/R2	0.8 0.8 0.17 0.38	1.0 1.0 0.21 0.47	1.2 1.2 0.25 0.56	
Q2 TRANSISTOR: NPN OFF CHARACTERISTICS						
Collector-Base Cutoff Current (	$V_{CB} = 50 \text{ V}, \text{ I}_{E} = 0)$	I <sub>CBO</sub>	-	-	100	nAdc
Collector-Emitter Cutoff Current	t (V <sub>CB</sub> = 50 V, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	-	500	nAdc
Emitter-Base Cutoff Current (V <sub>EB</sub> = 6.0 V, I <sub>C</sub> = 0)	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G, EMC5DXV5T1G	I <sub>EBO</sub>	_ _ _	_ _ _	0.2 0.5 0.1	mAdc
ON CHARACTERISTICS					•	•
Collector-Base Breakdown Volt	age (I <sub>C</sub> = 10 μA, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	50	-	-	Vdc
Collector-Emitter Breakdown Vo	bltage ( $I_{C} = 2.0 \text{ mA}, I_{B} = 0$ )	V <sub>(BR)CEO</sub>	50	-	-	Vdc
DC Current Gain $(V_{CE} = 10 \text{ V}, I_C = 5.0 \text{ mA})$	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G, EMC5DXV5T1G	h <sub>FE</sub>	60 35 80	100 60 140	- - -	
Collector-Emitter Saturation Vo	Itage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0.3 mA)	V <sub>CE(SAT)</sub>	-	-	0.25	Vdc
Output Voltage (on) (V <sub>CC</sub> = 5.0	V <sub>OL</sub>	_	_	0.2	Vdc	
Output Voltage (off) ( $V_{CC} = 5.0$		V <sub>OH</sub>	4.9	_	_	Vdc
Input Resistor	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G, EMC5DXV5T1G	R1	15.4 7.0 33	22 10 47	28.6 13 61	kΩ
Resistor Ratio	EMC2DXV5T1G EMC3DXV5T1G EMC4DXV5T1G, EMC5DXV5T1G	R1/R2	0.8 0.8 0.8	1.0 1.0 1.0	1.2 1.2 1.2	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

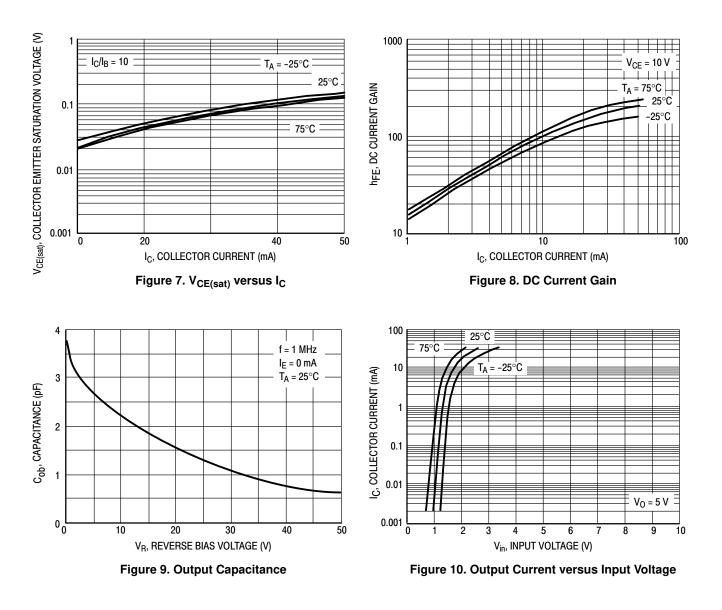
**TYPICAL ELECTRICAL CHARACTERISTICS – EMC2DXV5T1 PNP TRANSISTOR** 

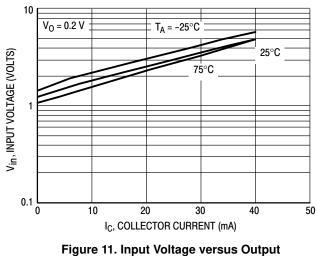






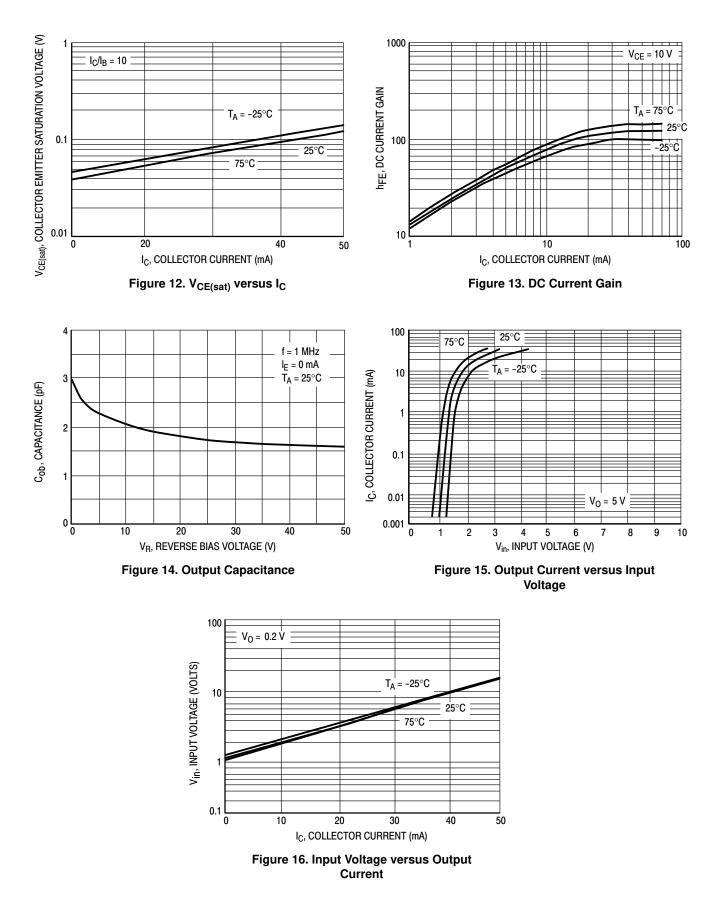
**TYPICAL ELECTRICAL CHARACTERISTICS – EMC2DXV5T1 NPN TRANSISTOR** 



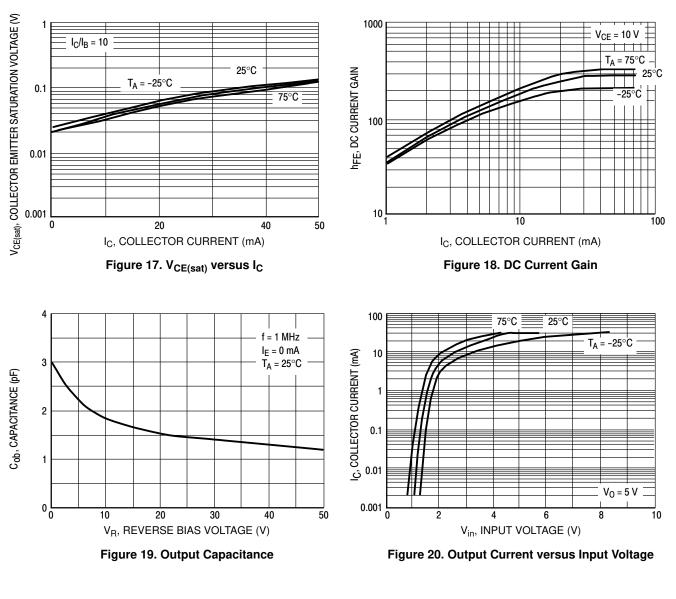


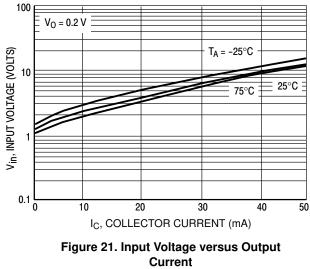
Current

**TYPICAL ELECTRICAL CHARACTERISTICS – EMC3DXV5T1 PNP TRANSISTOR** 



**TYPICAL ELECTRICAL CHARACTERISTICS – EMC3DXV5T1 NPN TRANSISTOR** 





**TYPICAL ELECTRICAL CHARACTERISTICS - EMC4DXV5T1 PNP TRANSISTOR** 

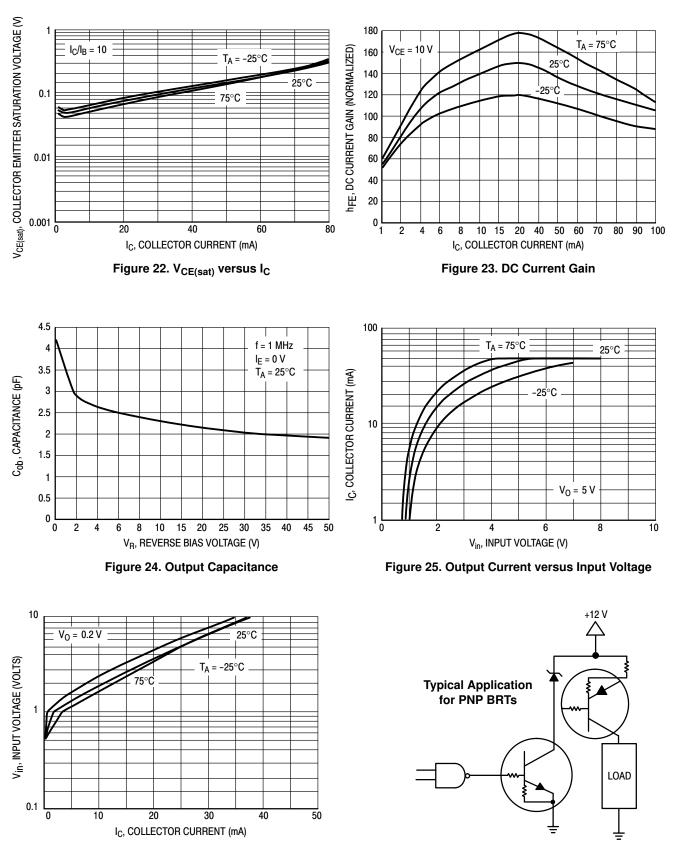


Figure 26. Input Voltage versus Output Current

Figure 27. Inexpensive, Unregulated Current Source

TYPICAL ELECTRICAL CHARACTERISTICS – EMC5DXV5T1 PNP TRANSISTOR

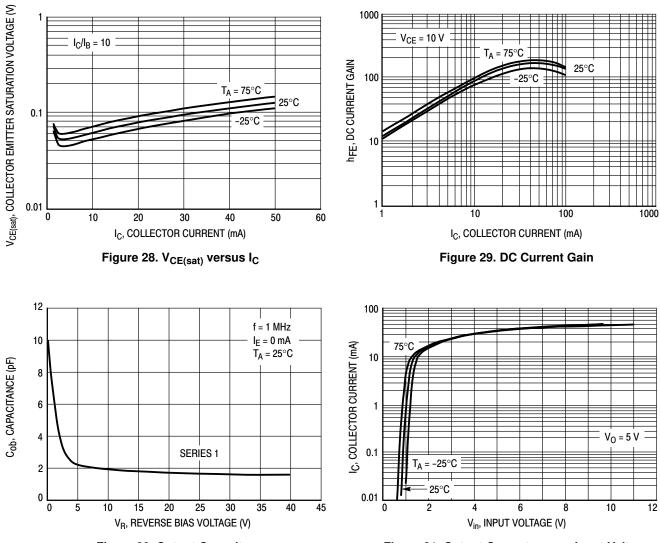


Figure 30. Output Capacitance

Figure 31. Output Current versus Input Voltage

TYPICAL ELECTRICAL CHARACTERISTICS - EMC4DXV5T1, EMC5DXV5T1 NPN TRANSISTOR

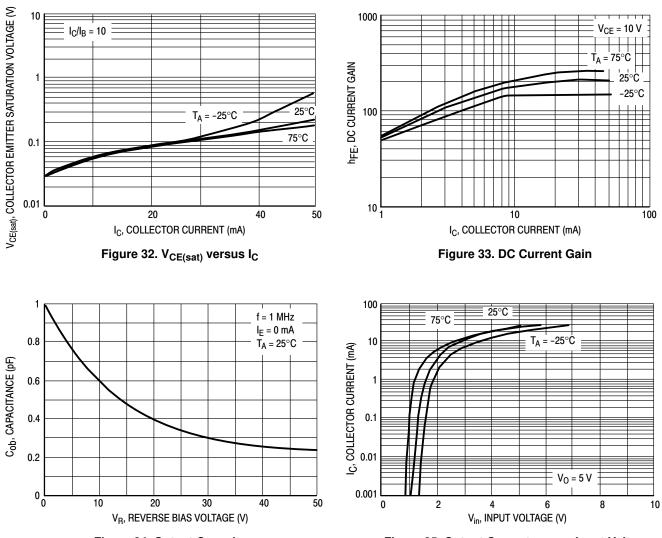


Figure 34. Output Capacitance

Figure 35. Output Current versus Input Voltage

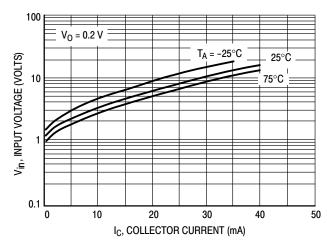
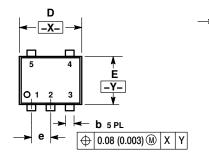
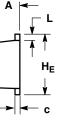


Figure 36. Input Voltage versus Output Current

#### PACKAGE DIMENSIONS

SOT-553, 5 LEAD CASE 463B ISSUE C





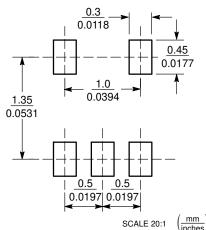
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: MILLIMETERS 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH

THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.50	0.55	0.60	0.020	0.022	0.024	
b	0.17	0.22	0.27	0.007	0.009	0.011	
С	0.08	0.13	0.18	0.003	0.005	0.007	
D	1.55	1.60	1.65	0.061	0.063	0.065	
E	1.15	1.20	1.25	0.045	0.047	0.049	
е	0.50 BSC			0.020 BSC			
L	0.10	0.20	0.30	0.004	0.008	0.012	
ΗE	1.55	1.60	1.65	0.061	0.063	0.065	

RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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